Qty	Reference	Value	Description	Size	Part Nunber	Manufacturer
6	C2-3 C5-6 C8 C10	10uF	Capacitor, Ceramic, 6.3V, X5R, ±20%	603	Std	TDK
2	C11-12	1uF	Capacitor, Ceramic, 6.3V, X7R, ±10%	603	Std	Std
3	L1-3	1uH	Inductor, 1uH, 2.7A, 0.045 Ohm	2.5 x 2.0mm	MAMK2520T1R0M	Taiyo Yuden
1	Q1	2N7002W	MOSFET, Nch, 60V, 115mA	SOT-323	2N7002W	Fairchild
1	R1	0	Resistor, Chip, 1/16W, 1%	603	Std	Std
4	R7 R9 R13-14	100k	Resistor, Chip, 1/16W, 1%	603	Std	Std
1	R11	118k	Resistor, Chip, 1/16W, 1%	603	Std	Std
1	R8	200k	Resistor, Chip, 1/16W, 1%	603	Std	Std
3	R4 R6 R12	39.2k	Resistor, Chip, 1/16W, 1%	603	Std	Std
1	R5	47.5k	Resistor, Chip, 1/16W, 1%	603	Std	Std
1	R3	78.7k	Resistor, Chip, 1/16W, 1%	603	Std	Std
3	U1-3	TLV62080DSG	IC, 1.3A Sync. Step Down Converter	SON-8	TLV62080DSG	TI
1	U4	TLV70025DDC	IC, 200mA, Low IQ, LDO Regulator	TSOT23-5	TLV70025DDC	TI
	MISC					
1	J1	SDA-90122-140	Header, 2X20 RA 100 mil spacing	0.36 x 2.00"	SDA-90122-140	Molex
	TP1-2 TP4 TP6-7					
13	TP9-10 TP12-17		Test Point, Red, Thru Hole		5000	
	TP3 TP5 TP8					
4	TP11		Test Point, Black, Thru Hole		5001	
3	C4 C7 C9	open	Capacitor, Ceramic, 6.3V, X5R, ±20%	603		TDK
1	C1	open	Capacitor, Ceramic, 6.3 V, X5R, ±20%	1206		TDK
1	R2	open	Resistor, Chip, 1/16W, 1%	603		Std

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